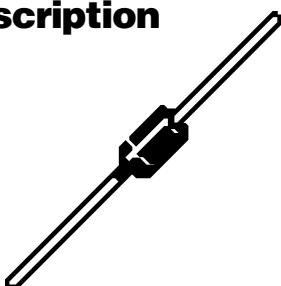
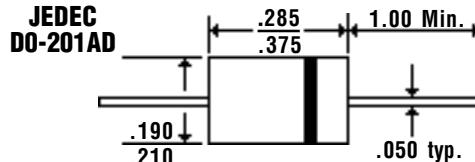


Description



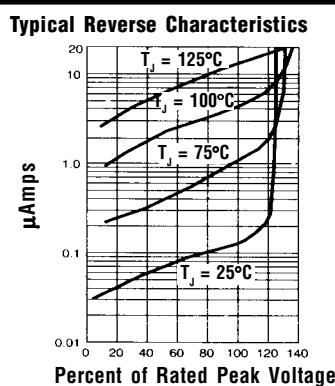
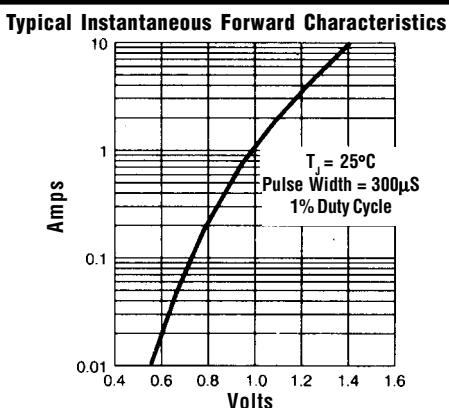
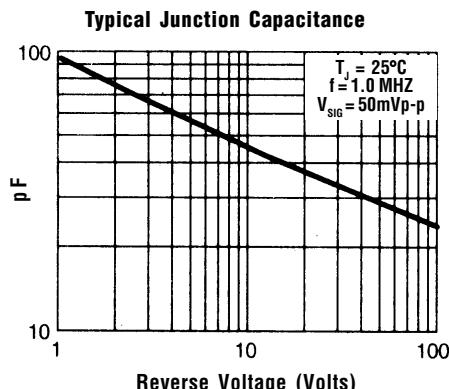
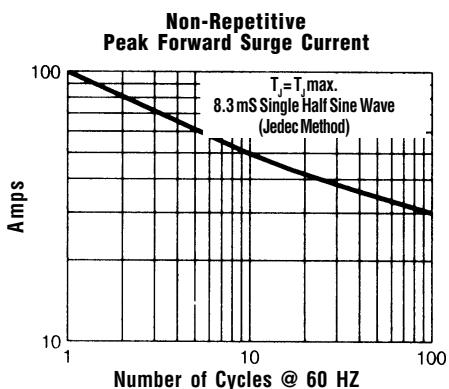
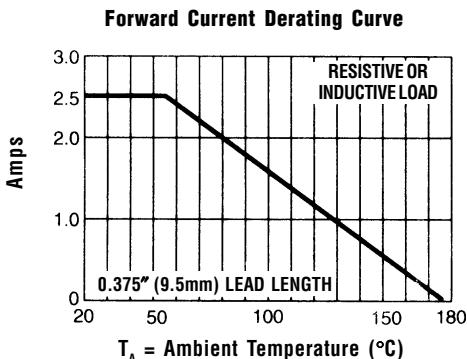
Mechanical Dimensions



Features

- HIGH TEMPERATURE METALLURGICALLY BONDED CONSTRUCTION
- SINTERED GLASS CAVITY-FREE JUNCTION
- 2.5 AMP OPERATION @ $T_A = 55^\circ\text{C}$, WITH NO THERMAL RUNAWAY
- TYPICAL $I_R < 0.1 \mu\text{Amp}$

Electrical Characteristics @ 25°C.	RGP25A . . . 25M Series							Units
Maximum Ratings	RGP25A	RGP25B	RGP25D	RGP25G	RGP25J	RGP25K	RGP25M	
Peak Repetitive Reverse Voltage... V_{RRM}	50	100	200	400	600	800	1000	Volts
RMS Reverse Voltage... $V_{R(rms)}$	35	70	140	280	420	560	700	Volts
DC Blocking Voltage... V_{DC}	50	100	200	400	600	800	1000	Volts
Average Forward Rectified Current... $I_{F(av)}$ Current 3/8" Lead Length @ $T_A = 55^\circ\text{C}$	2.5	Amps
Non-Repetitive Peak Forward Surge Current... I_{FSM} 8.3mS, ½ Sine Wave Superimposed on Rated Load	100	Amps
Forward Voltage @ Rated Forward Current and 25°C... V_F	1.3	Volts
Full Load Reverse Current... $I_R(\text{av})$ Full Cycle Average @ $T_A = 55^\circ\text{C}$	100	μAmps
DC Reverse Current... I_R @ Rated DC Blocking Voltage	$T_A = 25^\circ\text{C}$	5.0	μAmps
	$T_A = 125^\circ\text{C}$	200	μAmps
Typical Junction Capacitance... C_J (Note 1)	60	pF
Typical Thermal Resistance... R_{QJA} (Note 2)	16	°C/W
Typical Reverse Recovery Time... t_{RR} (Note 3)	<	150	> 250	< 500	>	nS
Operating & Storage Temperature Range... T_J , T_{STRG}	-65 to 175	°C



Ratings at
25 Deg. C ambient
temperature
unless otherwise
specified.

Single Phase Half
Wave, 60 HZ
Resistive or
Inductive Load.

For Capacitive
Load, Derate
Current by 20%.

- NOTES:**
1. Measured @ 1 MHZ and applied reverse voltage of 4.0V.
 2. Thermal Resistance from Junction to Ambient at 3/8" Lead Length, P.C. Board Mounted.
 3. Reverse Recovery Condition I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A.